TOSHIBA Photocoupler GaAs Ired & Photo-Triac

TLP360J

Triac Drivers

Programmable Controllers

AC-Output Modules

Solid State Relays

TOSHIBA TLP360J consists of a photo-triac optically coupled to a gallium arsenide infrared-emitting diode in a four-lead plastic DIP package.

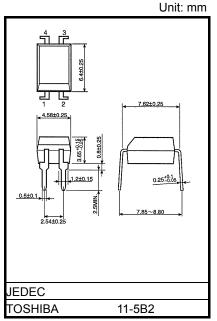
- Peak off-state voltage: 600 V (Min.)
- Trigger LED current: 10 mA (Max.)
- · On-state current: 100 mA (Max.)
- Isolation voltage: 5000 Vrms (Max.)
- UL recognized: UL1577, file No. E67349
- · Option (D4) type

TÜV approved: DIN EN60747-5-2

Certificate No. R50033433

 $\begin{tabular}{lll} Maximum operating insulation voltage & : 890 Vpk \\ Maximum permissible overvoltage & : 8000 Vpk \\ \end{tabular}$

(Note) When an EN60747-5-2 approved type is needed, please designate "Option (D4)."

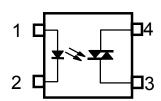


Weight: 0.26 g (typ.)

· Construction mechanical rating

	7.62 mm pitch standard type	10.16 mm pitch TLPXXXF type
Creepage distance Clearance	7.0 mm (min) 7.0 mm (min)	8.0 mm (min) 8.0 mm (min)
Insulation thickness	0.4 mm (min)	0.4 mm (min)

Pin Configuration (top view)



- 1: Anode
- 2: Cathode
- 3: Terminal1
- 4: Terminal2

Trigger LED Current

Classi– fication*	Trigger LED $V_T = 6 V$,	Marking of classification	
lication	Min.	Max.	Classification
(IFT7)	1	7	T7
Standard	_	10	T7, blank

^{*}Example: "(IFT7)"; "TLP360J(IFT7)"

(Note) When specifying the application type name for certification testing, be sure to use the standard product type name, e.g., TLP360J(IFT7): TLP360J.

Absolute Maximum Ratings (Ta = 25°C)

Characteristic			Symbol	Rating	Unit	
Forward current		lF	50	mA		
	Forward current derating (Ta ≥ 53°C)		ΔI _F /°C	-0.7	mA /°C	
ED	Peak forward current (100 µs pulse, 100 pps)		I _{FP}	1	Α	
	Reverse voltage		V _R	5	V	
	Junction temperature		Tj	125	°C	
	Off-state output terminal voltage		V_{DRM}	600	V	
	On-state RMS current	Ta = 25°C	I=	100	mA	
_	On-state (NWO current	Ta = 70°C	IT(RMS)	50		
Detector	On-state current derating (Ta ≥ 25°C)		ΔI _T /°C	-1.1	mA /°C	
Ŏ	Peak on-state current (100 µs pulse, 120 pps)		I _{TP}	2	Α	
	Peak nonrepetitive surge current (Pw = 10 ms)		I _{TSM}	1.2	Α	
	Junction temperature	Tj	115	°C		
Stor	Storage temperature range			-55 to 125	°C	
Оре	Operating temperature range			-40 to 100	°C	
Lea	Lead soldering temperature (10 s)			260	°C	
Isola	Isolation voltage (AC, 1 min., R.H.≤ 60%) (Note 1)			5000	Vrms	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Pins 1 and 2 are shorted together and pins 3 and 4 are shorted together.

Recommended Operating Conditions

Characteristic	Symbol	Min.	Тур.	Max.	Unit		
Supply voltage	V_{AC}	_	_	240	V_{ac}		
Forward current	lF	15	20	25	mA		
Peak on-state current	I _{TP}	_	_	1	Α		
Operating temperature	T _{opr}	-25	-	85	°C		

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

Electrical Characteristics (Ta = 25°C)

	Characteristic	Symbol	Test Condition		Тур.	Max.	Unit
	Forward voltage	VF	I _F = 10 mA	1.0	1.15	1.3	V
LED	Reverse current	I _R	V _R = 5 V	_	_	10	μA
	Capacitance	C _T	V = 0, f = 1 MHz	_	30	_	pF
	Peak off-state current	I _{DRM}	V _{DRM} = 600 V	_	10	1000	nA
١.	Peak on-state voltage	V _{TM}	I _{TM} = 100 mA	_	1.7	3.0	V
Detector	Holding current	lΗ	_	_	0.6	_	mA
Det	Critical rate of rise of off-state voltage	dv/dt	Vin = 240 Vrms , Ta = 85°C (Note 2)	_	500	_	V/µs
	Critical rate of rise of commutating voltage	dv/dt(c)	Vin = 60 Vrms , I _T = 15 mA (Note 2)	_	0.2		V/µs

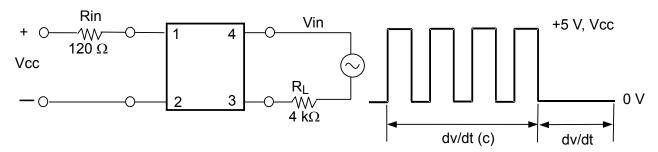
Coupled Electrical Characteristics (Ta = 25°C)

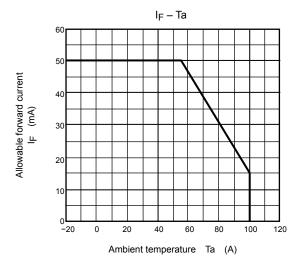
Characteristic	Symbol	Test Condition	Min.	Тур.	Max.	Unit
Trigger LED current	I _{FT}	V _T = 6 V	_	_	10	mA
Turn-on time	t _{ON}	$V_D = 6 \rightarrow 4 \text{ V}$, $R_L = 100 \Omega$ $I_F = \text{Rated} I_{FT} \text{X} 1.5$	_	30	100	μs

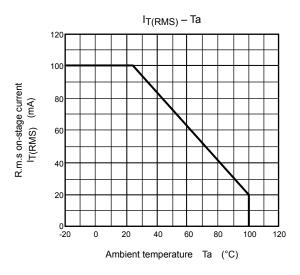
Isolation Characteristics (Ta = 25°C)

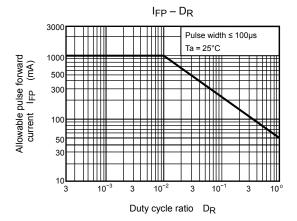
Characteristic	Symbol	Test Condition	Min.	Тур.	Max.	Unit
Capacitance (input to output)	Cs	V _S = 0 , f = 1 MHz	_	8.0	_	pF
Isolation resistance	R _S	V _S = 500 V, R.H. ≤ 60%	1×10 ¹²	10 ¹⁴	_	Ω
Isolation voltage	BVS	AC, 1 minute	5000	_	_	Vrms
		AC, 1 second, in oil	_	10000	_	VIIIIS
		DC, 1 minute, in oil	_	10000	_	Vdc

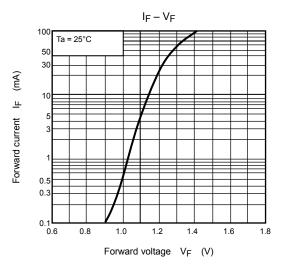
(Note 2): dv/dt test circuit

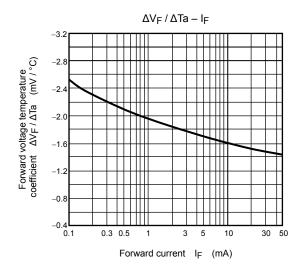


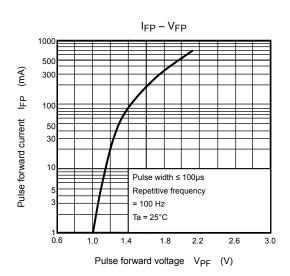




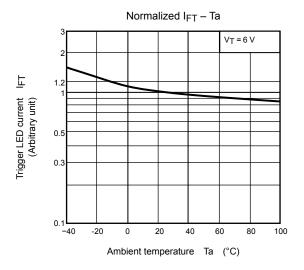


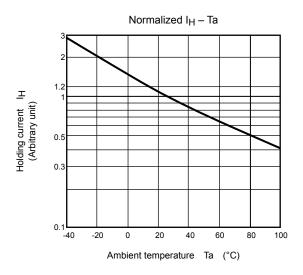


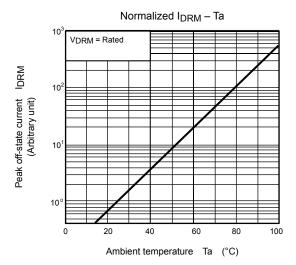


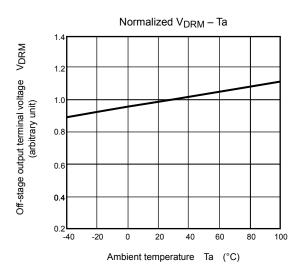


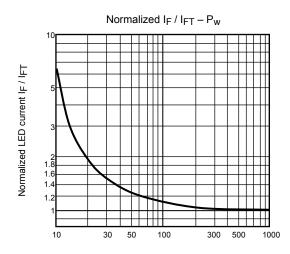
^{*:} The above graphs show typical characteristics.











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